## PMP9397

Designator	Quantity	Manufacturer	PackageReference	PartNumber	Value
C1	1	ТДК	1210	C3225X7R1H335M	3.3uF
C2	1	Panasonic	SMT Radial D8	EEE-FK1H470XP	47uF
C3	1	MuRata	1206	GRM31MR61A106KE19L	10uF
C4	1	Murata Electronics	1206 (3216 metric)	GRM31C5C1H104JA01K	0.1 uF
C5	1	MuRata	0603	GRM188R71H103KA01D	0.01uF
C6	1	Panasonic		EEF-UE0K101XR	100 uF
C7	1				N/A
C8	1	MuRata	0603	GRM188R71H472KA01D	4700pF
C9	1	MuRata	0603	GRM1885C1H470JA01D	47pF
C10	1	N/A	N/A		N/A
CF	1	MuRata	1210	GRM32ER71H106KA12L	10uF
CF0, CF3, CF4	3	MuRata	0805	GQM2195C1H101JB01D	100pF
CF1, CF2	2	MuRata	1206	GRM31CR71H475KA12L	4.7uF
D1	1	International Rectifier	SMC	30BQ060TRPBF	60V
EN	1	Keystone	Keystone5014	5014	Yellow
FPWM, VBIAS	2	Samtec	3x1 Header	TSW-103-07-G-S	
GND, PGND, VOUT, Vsupp	4	Keystone	Keystone1503-2	1503-2	Double
GND1	1	Keystone	Keystone5014	5014	Yellow
IC1	1	Texas Instruments	16-TSSOP (0.173", 4.40mm	LM26001MXA	
L1	1	ТDК		SLF12565T-220M3R5-H	
LF	1	Coilcraft	MSD1260	MSD1260-103MLB	10uH
LF1, LF2	2	Coilcraft	LPS5030	LPS5030-682MLB	6.8uH
PGOOD	1	Keystone	Keystone5014	5014	Yellow
R1	1	Yageo America	0603	RC0603FR-0756K2L	56.2k
R2	1	Yageo America	0603	RC0603FR-0733KL	33.0k
R3	1	Yageo America	0603	RC0603FR-07120KL	120k
R4	1	Yageo America	0603	RC0603FR-07200KL	200k
R5	1	Yageo America	0603	RC0603FR-0715KL	15.0k
R6	1	Yageo America	0603	RC0603FR-0710KL	10.0k
SYNC	1	Keystone	Keystone5014	5014	Yellow

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